

### **PART NUMBER**

## **COMPONENT SPECIFICATION**



# Component Specification for Ceramic Hermetically Sealed, Radiation Hard Optically Coupled Solid State Relay

Features	Applications
Compact Isolation Solid State Switches	Space equipment and systems
<ul> <li>Continuous Output Current of 0.8A</li> </ul>	<ul> <li>Military equipment and hi-reliability systems</li> </ul>
3A Output Surge	<ul> <li>Aircraft Controls</li> </ul>
High Level of Transient Immunity	<ul> <li>Electromechanical and Solid State Relay Replacement</li> </ul>
<ul> <li>Optically Coupled between Input and Output</li> </ul>	<ul> <li>Computer Systems</li> </ul>
<ul> <li>Space/Military Screening available</li> </ul>	<ul> <li>Motor Driver</li> </ul>
<ul> <li>Full Military temperature range -55°C to +125°C</li> </ul>	H Bridge Driver

## **DESCRIPTION**

The CSMR140 is a power MOSFET optocoupler housed in a 4 Pin LCC package, designed for applications where independent switches with radiation-tolerant performance are necessary. With 1000 V<sub>DC</sub> isolation between input/output isolated relay, the CSMR140 is well-suited for solid-state relay applications. Its performance is rated for the full military temperature range, making it ideal for demanding environments.

Functionally, the CSMR140 acts as (Single Pole Single Throw), normally open (2 Form A) solid-state relay. The relay is activated by an input current, typically driven by a standard TTL device. The input current biases an AlGaAs emitter that is optically coupled to an integrated diode array, which in turn powers control circuitry to operate the output power MOSFET.

The device is available with screening in accordance with MIL-PRF-38534, Class K/H, or custom screening options or as COTS. The lead options support both through-hole and surface-mount assemblies, with gold-plated leads being standard, though other lead finishes are available.

#### **Key Features:**

- Radiation Tolerant: While the device contains radiation-hardened components, the specific radiation
  hardness must be determined through lot-specific testing,
- **High Voltage Isolation:** 1000 V<sub>DC</sub> isolation between input/output and the relays, ensuring robust performance in high-voltage environments.
- Versatile Packaging: Supports surface-mount assembly, with various lead finishes available.

This single MOSFET optocoupler is suitable for military and aerospace applications where high reliability, radiation tolerance, and solid-state relay functionality are required.











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### **STANDARDS**

The following specifications have been complied with in the manufacturing of this product -

#### **Aerospace Compliance Standards**

AS9100D & ISO 9001:2015 - Design & Manufacture of Electronic and Optoelectronic Components (Ref GB15/92780)

#### **Military Compliance Specifications**

MIL-PRF-38534 - General Specification for Hybrid Microcircuits

MIL-PRF-19500 - General Specification for Discrete Semiconductor Devices

## **Military Compliance Standards**

MIL-STD-202 - Test Method Standard Electronic and Electrical Component Parts

MIL-STD-883 - Test Method Standard Microcircuits

MIL-STD-750 - Test Method Standard for Semiconductor Devices

## SCREENING INFORMATION

Our products can be screened to MIL-PRF-38534, applying test methods from MIL-STD-883; MIL-PRF-19500, applying test methods of MIL-STD-750; or a combination thereof. Please contact us for more information relating to the applicable screening processes.

#### AMENDMENT RECORD

Issue No.	Date	Description
1	January 2017	First issue
2	November 2018	Updated Quality Management Section. Removed IECQ Logos.
3	January 2021	Removed Screening and Group Testing Information
4	August 2022	Updated Formatting
5	September 2022	Updated Functional Diagram
6	February 2023	Updated Electrical data
7	April 2023	Updated Functional Diagram
8	August 2024	Correction on test parameters and Package details
9	September 2024	Updated Template, Functional Diagrams and Added Screening Flow

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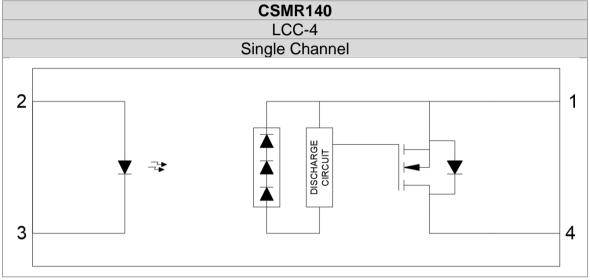
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## PACKAGE STYLES AND CONFIGURATION OPTIONS

Package	4-Pin LCC			
Lead Style	-			
Channels	1			
Common Channel Wiring	-			
Isocom Part Number and Options				
Commercial	CSMR140			
Defense Screen Level	CSMR140/L2			
Space Screen Level	CSMR140/L2S			
Standard Gold Plate Finish	Gold Plate			
Solder Dipped	Option #20			

# **FUNCTIONAL DIAGRAMS**



# TRUTH TABLE

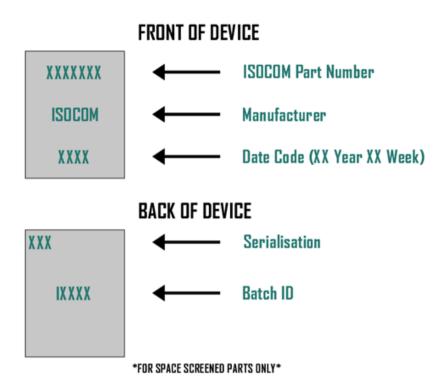
CSMR140 Truth Table				
INPUT OUTPUT				
HIGH	CLOSED			
LOW	OPEN			

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## **DEVICE MARKING**



## **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25$ °C U.O.S

Storage Temperature	-65°C to +150°C
Operating Temperature – T <sub>A</sub>	-55°C to +125°C
Junction Temperature – T <sub>J</sub>	+150°C
Lead Soldering Temperature (for 10 seconds)	260°C (1.6mm below seating plane)
Average Input Current – IF	20 mA
Peak Repetitive Input Current – IFpk	40 mA (pulse width < 100mS; duty cycle < 50%)
Peak Surge Input Current – IFpk surge	100 mA (pulse width < 0.2mS; duty cycle < 0.1%)
Continuous Output Current per relay –	0.8 A
lo	
Peak Surge Output Current – IOpk surge	3.0 A (pulse width < 10ms)
Output Voltage – Vo	100 V <sub>DC</sub>
Input-to-Output Isolation Voltage	ऐ1000 Vpc

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## RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Units
Input Current (ON)	I <sub>F(ON)</sub>	10	20	mA
Input Voltage (OFF)	V <sub>F(OFF)</sub>	0	0.6	V <sub>DC</sub>
Operating Temperature	TA	-55	+125	°C

## **ELECTRICAL CHARACTERISTICS**

 $T_A = -55 \text{ to } +125^{\circ}\text{C U.O.S}$ 

Devemeter	Cymphal	Symbol Conditions		Limits	
Parameter	Symbol			Max	Unit
Output Withstand Voltage	Vo(OFF)	$V_F(OFF) = 0.6V, I_O = 10\mu A$	100	_	V
Output On-Resistance	R(ON)	I <sub>FON</sub> = 10mA, I <sub>O</sub> = 800mA, pulse duration ≤30ms, duty cycles < 10%	_	0.9	Ω
Output Leakage Current	Io(OFF)	$V_F(OFF) = 0.6V, V_O = 100V$	_	10	μA
Input Forward Voltage	V <sub>F</sub> (ON)	I <sub>F</sub> (ON) = 10mA	1.0	1.7	V
Input Reverse Breakdown Voltage	VR	I <sub>R</sub> = 10μA	5.0	_	V
Input-Output Isolation Current	l <sub>i-0</sub>	$V_{I-O} = 1000 \text{vdc}, t = 5\text{s},$ $R_H \le 45\%. T_A = 25^{\circ}\text{C}$	_	1.0	μA
Turn-On Time	T(ON)	I <sub>F</sub> (ON) = 10mA, I <sub>O</sub> = 800mA, pulse duration ≤ 30 ms, duty cycles < 10%	_	6.0	ms
Turn-Off Time	T(OFF)	I <sub>F</sub> (ON) = 10mA, I <sub>O</sub> = 800mA, pulse duration ≤ 30 ms, duty cycles < 10%	_	2.0	ms

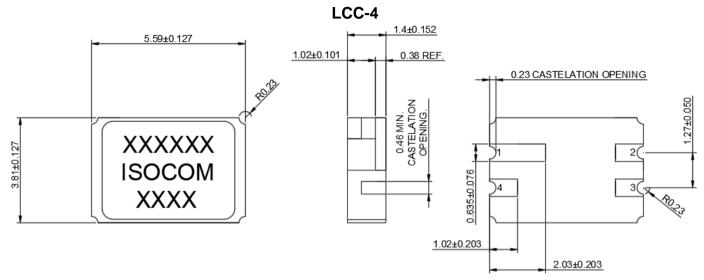
#### Notes

- 1. Maximum average current rating where the case temperature (T<sub>C</sub>) is maintained below 120°C.
- 2. During the pulsed R(ON) measurement (Io duration < 30ms), ambient (TA) and case temperature (Tc) are equal.
- 3. This is a momentary withstand test, not a continuous operating condition.
- 4. Typical junction to case thermal resistance (R<sub>eJC</sub>) for the device is 15°C/W, where the case temperature (T<sub>C</sub>) is measured at the centre of the package bottom.

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# **OUTLINE DRAWINGS**

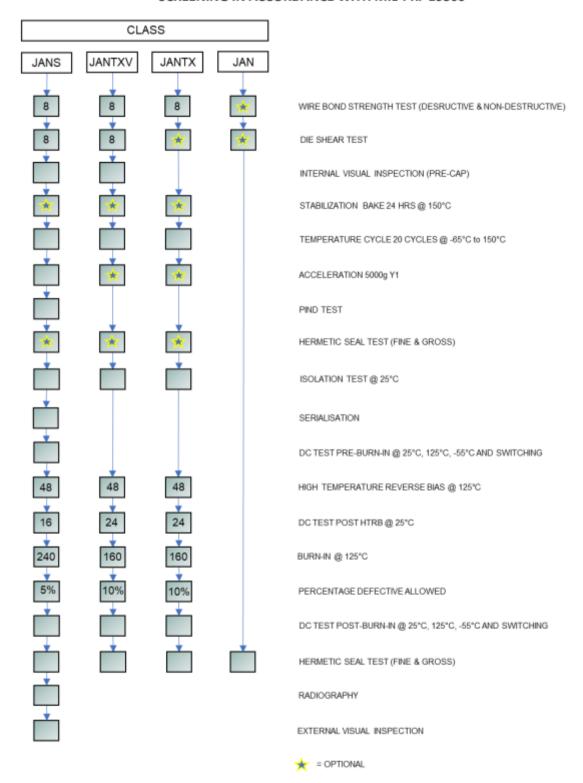


## **PIN OUT INFORMATION**

Pin Number	Pin Function
1	Source
2	Anode
3	Cathode
4	Drain



#### **SCREENING IN ACCORDANCE WITH MIL-PRF 19500**



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The following screening flow includes the electrical tests between each screening step, the referenced test method from MIL-STD 750 and the sample basis for Class JANTX, JANTXV and JANS quality levels.

Operation					
No.	Operation	MIL-PRF 19500	JANTX (L2)	JANTXV (L2)	JANS (L2S)
1	Wire bond strength (ND)	(883) 2023	100%	100%	100%
2	Wire bond strength (D)	(750) 2037, Con D	4 devices	4 devices	8 devices
3	Die Shear	(750) 2017	4 devices	4 devices	8 devices
4	Internal Visual	(750) 2072	Optional	100%	100%
5	Stabilization Bake		Optional	Optional	Optional
6	Electrical Test @ 25°C		100%	100%	100%
7	Temp cycle (20 cycles @ -65°C to 150°C)	(750) 1051, Con F	100%	100%	100%
8	Electrical Test @ 25°C		100%	100%	100%
9	Constant acceleration	(750) 2006, 5000g, Y1	Optional	Optional	100%
10	Electrical Test @ 25°C		100%	100%	100%
11	P.I.N.D	(750) 2052, Con A	N/A	N/A	100%
12	Electrical Test @ 25°C		N/A	N/A	100%
13	Fine leak, Helium bomb, -Leak detector	(750) 1071 Con H1	Optional	Optional	Optional
14	Gross leak, Liquid bomb, Bubble chamber	(750) 1071, Con C	Optional	Optional	Optional
15	Serialisation of devices		N/A	N/A	100%
16	Isolation 100% @ 25°C	(MIL-STD 202) 301	100%	100%	100%
17	Electrical Test @ 25°C		100%	100%	100%
18	Electrical Test @ 125°C		100%	100%	100%
19	Electrical Test @ -55°C		100%	100%	100%
20	Switching time @ 25°C		100%	100%	100%
21	HTRB (125°C)	(750) 1039, Con A (80% VDS)	100% (48 hrs)	100% (48 hrs)	100% (48 hrs)
22	Electrical Test @ 25°C		100% (24 hrs)	100% (24 hrs)	100% (16 hrs)
23	Burn-In (125°C)	(750) 1039, Con B (80% VDS)	100% (160 hrs)	100% (160 hrs)	100% (240 hrs)
24	Percentage defective allowable	Pre/post Burn-in electrical and delta at 25°C only	100% @ 10% PDA	100% @ 10% PDA	100% @ 5% PDA
25	Electrical Test @ 25°C		100% (Group A, SG 2)	100% (Group A, SG 2)	100% (Group A, SG 2)
26	Electrical Test @ 125°C		100% (Group A, SG 3)	100% (Group A, SG 3)	100% (Group A, SG 3)
27	Electrical Test @ -55°C		100% (Group A, SG 3)	100% (Group A, SG 3)	100% (Group A, SG 3)
28	Switching time @ 25°C		100% (Group A, SG4)	100% (Group A, SG4)	100% (Group A, SG4)
29	Fine leak, Helium bomb, -Leak detector	(750) 1071 Con H1	100%	100%	100%
30	Gross leak, Liquid bomb, Bubble chamber	(750) 1071, Con C	100%	100%	100%
31	Radiography	(750) 2076	N/A	N/A	100%
32	External Visual	(750) 2071	N/A	N/A	100%

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# MIL-PRF 19500 TYPICAL QCI TESTING PROCESS FLOW

Group	Sub	Parameters	Quantity (accept number)			
Group	Group	rarameters	TM	JANS	JANTX, JANTXV	
	1	Visual and mechanical inspection	750-2071			
A (CI)	2	Static tests at +25°C	Datasheet	100%	100%	
A (CI)	3	Static tests at min and max. rated operating temp.	Datasheet	100%	10070	
	4	Dynamic test at +25°C	Datasheet			
		(JANS)		Large LOT (accept)	Small LOT (accept)	
	1	Physical dimension	750-2066	22 (0)	8 (0)	
	2	Solderability	750-2026	15 leads (0)	6 leads (0)	
		Temperature cycling (100 cycles)	750-1051			
		Hermetic seal (fine and gross leak)	750-1071	22 (0)	6 (0)	
		Electrical measurements	GRP-A- SG2	22 (0)	0 (0)	
B (PI)	3	Decap internal visual	750-2075	6 (0)	6 (0)	
5 (1)		Bond strength	750-2037	22 wires (0) or 11 (0)	12 wires (0) or 6 (0)	
		SEM	750-2077	11 (0)	6 (0)	
		Die shear	750-2017	11 (0)	6 (0)	
		Intermittent operation life (2000 cycles)	750-1037			
	4	Electrical measurements	GRP-A- SG2	22 (0)	12 (0)	
		(JANTXV, JANTX)		Large LOT (accept)	Small LOT (accept)	
	1	Solderability	750-2026	15 leads (0)	4 leads (0)	
		Temperature cycling (45 cycles incl. screening)	750-1051			
	2	Hermetic Seal (fine and gross leak)	750-1071	22 (0)	6 (0)	
	_	Electrical measurements	GRP-A-	(-/	- (-)	
			SG2			
B (PI)		Steady state op. life (340 Hrs) or	750-1026			
	3	intermittent op. life (2000 cycles)	or 750- 1037	45 (0)	12 (0)	
	3		GRP-A-	45 (0)	12 (0)	
		Electrical measurements	SG2			
	4	Decap internal visual	750-2075	1 (0)	1 (0)	

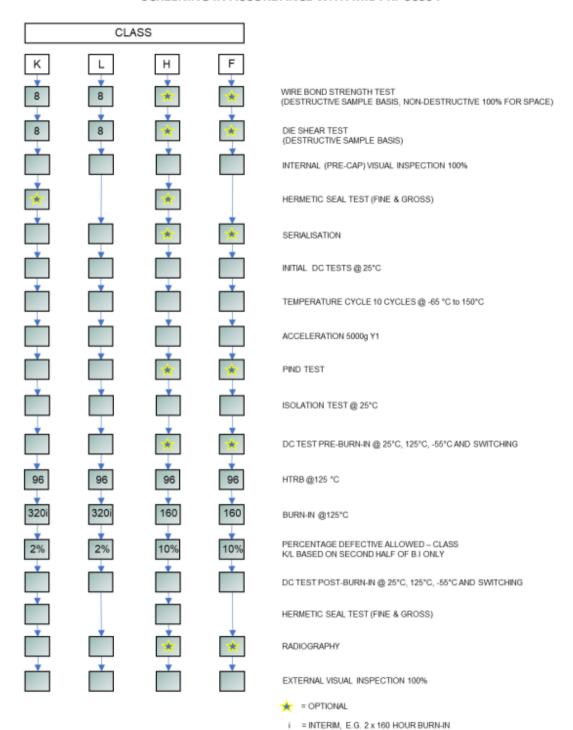


## MIL-PRF 19500 TYPICAL QCI TESTING PROCESS FLOW

Group	Sub Group	Parameters	ТМ	Sample plan	Small LOT (accept)
	1	Physical dimensions (Not Req. JANS)	750-2066	15 (0)	6 (0)
		Thermal shock (25 cycles, con B)	750-1056		
		Temperature cycling (45 cycles incl. screening)	750-1051		
	2	Terminal strength	750-2036	22 (0)	6 (0)
		Hermetic seal (fine and gross leak)	750-1071	22 (0)	6 (0)
		Electrical measurements	GRP-A-		
			SG2		
C (PI)		Constant acceleration (5000g, Y1 only)	750-2006	22 (0)	6 (0)
	3	Electrical measurements	GRP-A-		
		Liectifical measurements	SG2		
		Steady state op. life (1000 Hrs) or	750-1026		
		intermittent op. life (6000 cycles)	or 750-		
	6		1037	22 (0)	12 (0)
		Electrical measurements	GRP-A-		
			SG2		
	7	Internal Gas Analysis - Moisture 10,000 ppmv limit	750-1018	3 (0)	3 (0)



#### SCREENING IN ACCORDANCE WITH MIL-PRF 38534



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The following screening flow includes the electrical tests between each screening step, the referenced test method from MIL-STD 883 and the sample basis for Class K/L and H/F quality levels.

O	Operation	NII OTO ANA TEST HET HOS	Class		
Operation No.	Operation	MIL-STD 883 TEST METHOD	H/F (L2)	K/L (L28)	
1	Wire bond strength (ND)	(883) 2023	Optional	100%	
2	Wire bond strength (D)	(883) 2011	Optional	8 devices	
3	Die Shear	(883) 2019	Optional	8 devices	
4	Internal Visual	(883) 2017	100%	100%	
5	Fine leak, Helium bomb, Leak detector	(883) 1014, Con A1	Optional	Optional	
6	Gross leak, Liquid bomb, -Bubble chamber	(883) 1014, Con C1	Optional	Optional	
7	Serialisation of devices		Optional	100%	
8	Electrical Test 25°C		100%	100%	
9	Temp cycle @ -65°C to 150°C	(883) 1010, Con C, 10 cycles	100%	100%	
10	Electrical Test 25°C		100%	100%	
11	Constant acceleration	(883) 2001, 3000g, Y1	100%	100%	
12	Electrical Test 25°C		100%	100%	
13	P.I.N.D	(883) 2020, Con A	Optional	100%	
14	Electrical Test 25°C		100%	100%	
15	Isolation 100% @ 25°C	(MIL-STD 202) 301	100%	100%	
16	Electrical Test 25°C		100%	100%	
17	Electrical Test 125°C		Optional	100%	
18	Electrical Test -55°C		Optional	100%	
19	Switching time 100% @ 25°C		Optional	100%	
20	HTRB @ 125°C - 96 hrs	(883) 1015, con A	100%	100%	
21	Electrical Test 25°C		100%	100%	
22	Burn in @ 125°C	(883) 1015, con B	100% 160 hours	100% 160 hrs	
23	Electrical Test 25°C		100%	100%	
24	Burn in @ 125°C	(883) 1015, con B	N/A	100% 160 hrs	
25	Percentage defective allowable	Pre/post Burn-in electrical and delta at 25°C only	Max. 10%	Max. 2%	
26	Electrical Test 25°C	Group A - 9G1	100%	100%	
27	Electrical Test 125°C	Group A - SG2	100%	100%	
28	Electrical Test -55°C	Group A - SG3	100%	100%	
29	Switching time 100% @ 25°C	Group A - 9G9	100%	100%	
30	Fine leak, Helium bomb, Leak detector	(883) 1014, Con A1	100%	100%	
31	Gross leak, Liquid bomb, -Bubble chamber	(883) 1014, Con C1	100%	100%	
32	Radiography	(883) 2012	Optional	100%	
33	External Visual	(883) 2009	100%	100%	



# MIL-PRF 38534 TYPICAL QCI TESTING PROCESS FLOW

Group	Sub Group	Parameters	Quantity (accept number)		
			TM	К	н
A (CI)	1	Static tests at +25°C	Datasheet	100%	100%
	2	Static tests at max. rated operating temp.	Datasheet	100%	100%
	3	Static tests at min. rated operating temp.	Datasheet	100%	100%
	9	Switching tests at +25°C	Datasheet	100%	100%
				- 40	2.40
В (РІ)	1	Physical dimension	883-2016	2 (0)	2 (0)
	4	Internal visual and mechanical	883-2014	1 (0)	1 (0)
	5	Bond strength: Ultrasonic (on hotplate)	883-2011	2 (0)	2 (0)
	6	Die shear strength	883-2019	2 (0)	2 (0)
	7	Solderability	883-2003	1 (0)	1 (0)
	8	Seal: a. Fine, b. Gross	883-1014	N/A	15 (0)
		Estample invol	002 2000	5 (0)	5 (0)
C (PI)	1	External visual	883-2009	5 (0)	5 (0)
		Temperature Cycling	883-1010	5 (0)	5 (0)
		Constant acceleration	883-2001	X	5 (0)
		Seal (fine and gross)	883-1014	5 (0)	5 (0)
		PIND	883-2020	5 (0)	5 (0)
		Visual examination	883-1010	5 (0)	5 (0)
		End-point electrical	GRP-A	5 (0)	5 (0)
	2	Steady-state life test	883-1005	22 (0) or 5 (0)	22 (0) or 5 (0)
		End-point electrical	GRP-A	22 (0) or 5 (0)	22 (0) or 5 (0)
	3	Internal gas analysis	883-1018	3 (0) or 5 (1)	3 (0) or 5 (1)
		Moisture 10,000 ppmv limit			
	1	Thermal shock	883-1011	E (O)	E (O)
D (PI)				5 (0)	5 (0)
		Stabilization bake	883-1008	5 (0)	5 (0)
		Lead integrity	883-2004	1 (0)	1 (0)
		Seal: a. Fine, b. Gross	883-1014	5 (0)	5 (0)



## Summary of key differences between MIL-PRF 19500 and MIL-PRF 38534 for space level testing:

	MIL-PRF 19500 - JANS	MIL-PRF 38534 – Class K		
No. of Operation	32	33		
(Screening) Steps				
Optional				
Hermeticity	Occurs post P.I.N.D	Occurs post Internal Visual		
Testing				
Temp cycle - No.	20	10		
of Temp Cycles	20	10		
Acceleration -	5000g	3000g		
Amount of g force	3000g	5000g		
HTRB – No. of	48	96		
hours	40	30		
Burn-in – No. of	240 hrs in one successive burn-in	320 hrs (2 x 160 hrs with interim electrical)		
hours	240 file ill olic successive bulli-ill	520 ms (2 x 100 ms with interim electrical)		
PDA post burn-in	5% after 240 hrs burn-in	2% after second 160 hrs burn-in		



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